

N-channel 800 V, 2.8 Ω typ., 2.5 A MDmesh™ K5
Power MOSFETs in DPAK, TO-220FP, TO-220 and IPAK

Datasheet - production data

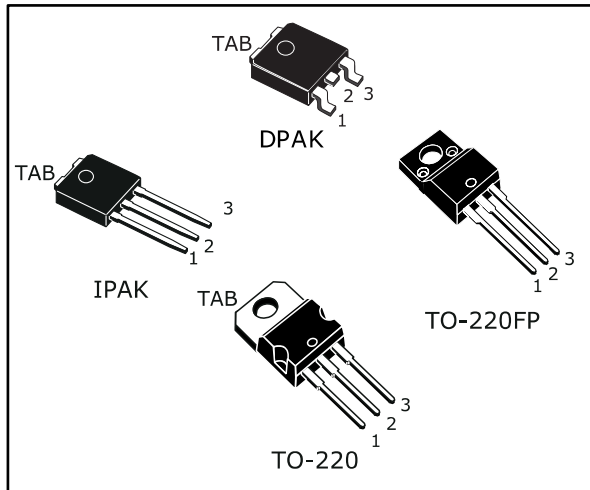
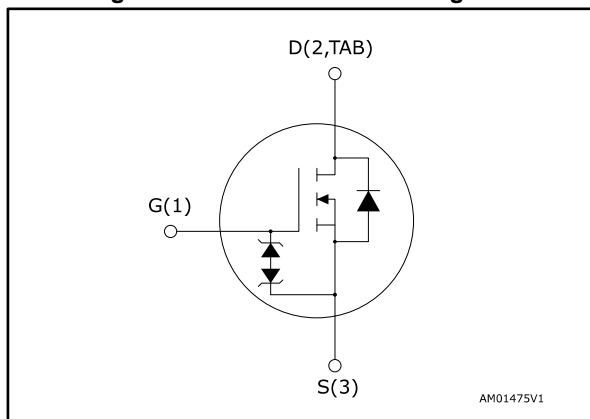


Figure 1: Internal schematic diagram



Features

| Order code | V _{DS} | R _{DS(on)} max. | I _D | P _{TOT} |
|------------|-----------------|--------------------------|----------------|------------------|
| STD3N80K5 | 800 V | 3.5 Ω | 2.5 A | 60 W |
| STF3N80K5 | | | | 20 W |
| STP3N80K5 | | | | 60 W |
| STU3N80K5 | | | | |

- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

- Switching applications

Description

These very high voltage N-channel Power MOSFETs are designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

| Order code | Marking | Package | Packing |
|------------|---------|----------|---------------|
| STD3N80K5 | 3N80K5 | DPAK | Tape and reel |
| STF3N80K5 | | TO-220FP | Tube |
| STP3N80K5 | | TO-220 | |
| STU3N80K5 | | IPAK | |

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1 Electrical ratings

Table 2: Absolute maximum ratings

| Symbol | Parameter | Value | | | | Unit |
|-------------------------------|---|------------|----------|--------|------|------|
| | | DKPAK | TO-220FP | TO-220 | IPAK | |
| V _{GS} | Gate-source voltage | ±30 | | | | V |
| I _D | Drain current (continuous) at T _C = 25 °C | 2.5 | | | | A |
| I _D | Drain current (continuous) at T _C = 100 °C | 1.6 | | | | A |
| I _D ⁽¹⁾ | Drain current (pulsed) | 10 | | | | A |
| P _{TOT} | Total dissipation at T _C = 25 °C | 60 | 20 | 60 | 60 | W |
| V _{ISO} | Insulation withstand voltage (RMS) from all three leads to external heat-sink (t = 1 s, T _C = 25 °C) | | 2.5 | | | kV |
| dv/dt ⁽²⁾ | Peak diode recovery voltage slope | 4.5 | | | | V/ns |
| dv/dt ⁽³⁾ | MOSFET dv/dt ruggedness | 50 | | | | |
| T _j | Operating junction temperature range | -55 to 150 | | | | °C |
| T _{stg} | Storage temperature range | | | | | |

Notes:

- (1)Pulse width limited by safe operating area.
- (2)I_{SD} ≤ 2.5 A, di/dt = 100 A/μs; V_{DS} peak < V_{(BR)DSS}.
- (3)V_{DS} ≤ 640 V.

Table 3: Thermal data

| Symbol | Parameter | Value | | | | Unit |
|-------------------------------------|-------------------------------------|-------|----------|--------|------|------|
| | | DKPAK | TO-220FP | TO-220 | IPAK | |
| R _{thj-case} | Thermal resistance junction-case | 2.08 | 6.25 | 2.08 | | °C/W |
| R _{thj-amb} | Thermal resistance junction-ambient | | 62.5 | 62.5 | 100 | °C/W |
| R _{thj-pcb} ⁽¹⁾ | Thermal resistance junction-pcb | 50 | | | | °C/W |

Notes:

- (1)When mounted on FR-4 board of 1 inch², 2 oz Cu.

Table 4: Avalanche characteristics

| Symbol | Parameter | Value | Unit |
|-----------------|--|-------|------|
| I _{AR} | Avalanche current, repetitive or not repetitive (pulse width limited by T _{jmax}) | 1 | A |
| E _{AS} | Single pulse avalanche energy (starting T _j = 25 °C, I _D = I _{AR} , V _{DD} = 50 V) | 65 | mJ |

2 Electrical characteristics

$T_C = 25\text{ °C}$ unless otherwise specified

Table 5: On/off-state

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------|-----------------------------------|--|------|------|----------|---------------|
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $V_{GS} = 0\text{ V}$, $I_D = 1\text{ mA}$ | 800 | | | V |
| I_{DSS} | Zero gate voltage drain current | $V_{GS} = 0\text{ V}$, $V_{DS} = 800\text{ V}$ | | | 1 | μA |
| | | $V_{GS} = 0\text{ V}$, $V_{DS} = 800\text{ V}$, $T_C = 125\text{ °C}^{(1)}$ | | | 50 | μA |
| I_{GSS} | Gate body leakage current | $V_{DS} = 0\text{ V}$, $V_{GS} = \pm 20\text{ V}$ | | | ± 10 | μA |
| $V_{GS(th)}$ | Gate threshold voltage | $V_{DD} = V_{GS}$, $I_D = 100\text{ }\mu\text{A}$ | 3 | 4 | 5 | V |
| $R_{DS(on)}$ | Static drain-source on-resistance | $V_{GS} = 10\text{ V}$, $I_D = 1\text{ A}$ | | 2.8 | 3.5 | Ω |

Notes:

⁽¹⁾Defined by design, not subject to production test.

Table 6: Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-------------------|---------------------------------------|---|------|------|------|----------|
| C_{iss} | Input capacitance | $V_{DS} = 100\text{ V}$, $f = 1\text{ MHz}$, $V_{GS} = 0\text{ V}$ | - | 130 | - | pF |
| C_{oss} | Output capacitance | | - | 14 | - | pF |
| C_{rss} | Reverse transfer capacitance | | - | 0.6 | - | pF |
| $C_{o(tr)}^{(1)}$ | Equivalent capacitance time related | $V_{GS} = 0\text{ V}$, $V_{DS} = 0\text{ to }640\text{ V}$ | - | 20 | - | pF |
| $C_{o(er)}^{(2)}$ | Equivalent capacitance energy related | | - | 9 | - | pF |
| R_g | Intrinsic gate resistance | $f = 1\text{ MHz}$, $I_D = 0\text{ A}$ | - | 15.5 | - | Ω |
| Q_g | Total gate charge | $V_{DD} = 640\text{ V}$, $I_D = 2.5\text{ A}$ $V_{GS} = 0\text{ to }10\text{ V}$ (see Figure 19: "Test circuit for gate charge behavior") | - | 9.5 | - | nC |
| Q_{gs} | Gate-source charge | | - | 1.5 | - | nC |
| Q_{gd} | Gate-drain charge | | - | 7.5 | - | nC |

Notes:

⁽¹⁾ $C_{o(tr)}$ is a constant capacitance value that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .

⁽²⁾ $C_{o(er)}$ is a constant capacitance value that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .

Table 7: Switching times

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|--------------|---------------------|---|------|------|------|------|
| $t_{d(on)}$ | Turn-on delay time | $V_{DD} = 400\text{ V}$, $I_D = 1.25\text{ A}$, $R_G = 4.7\ \Omega$ $V_{GS} = 10\text{ V}$ (see Figure 18: "Test circuit for resistive load switching times" and Figure 23: "Switching time waveform") | - | 8.5 | - | ns |
| t_r | Rise time | | - | 10.5 | - | ns |
| $t_{d(off)}$ | Turn-off delay time | | - | 20.5 | - | ns |
| t_f | Fall time | | - | 25 | - | ns |

Table 8: Source-drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------|-------------------------------|--|------|------|------|---------------|
| I_{SD} | Source-drain current | | - | | 2.5 | A |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) | | - | | 10 | A |
| $V_{SD}^{(2)}$ | Forward on voltage | $I_{SD} = 2.5\text{ A}$, $V_{GS} = 0\text{ V}$ | - | | 1.5 | V |
| t_{rr} | Reverse recovery time | $I_{SD} = 2.5\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$, $V_{DD} = 60\text{ V}$ (see Figure 20: "Test circuit for inductive load switching and diode recovery times") | - | 265 | | ns |
| Q_{rr} | Reverse recovery charge | | - | 1.2 | | μC |
| I_{RRM} | Reverse recovery current | | - | 9.2 | | A |
| t_{rr} | Reverse recovery time | $I_{SD} = 2.5\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$, $V_{DD} = 60\text{ V}$, $T_j = 150\text{ }^\circ\text{C}$ (see Figure 20: "Test circuit for inductive load switching and diode recovery times") | - | 430 | | ns |
| Q_{rr} | Reverse recovery charge | | - | 1.9 | | μC |
| I_{RRM} | Reverse recovery current | | - | 8.8 | | A |

Notes:

(1)Pulse width limited by safe operating area

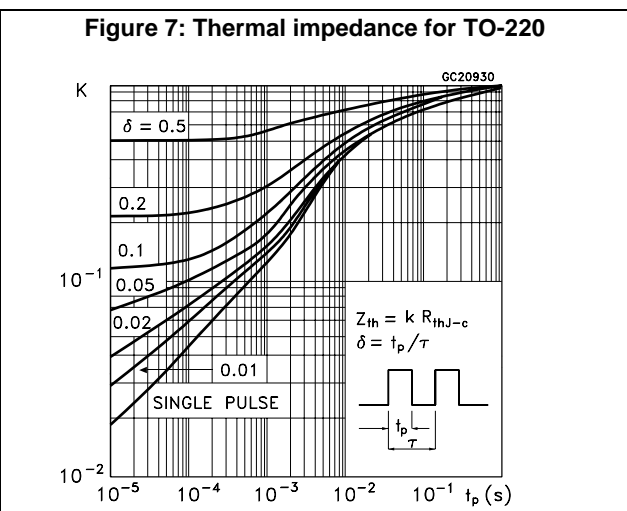
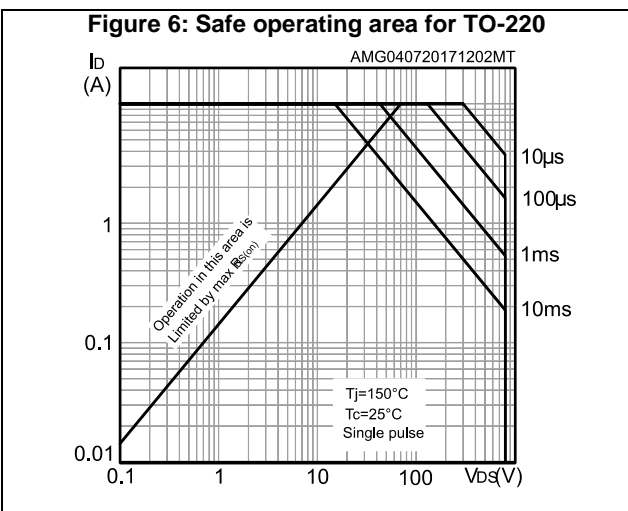
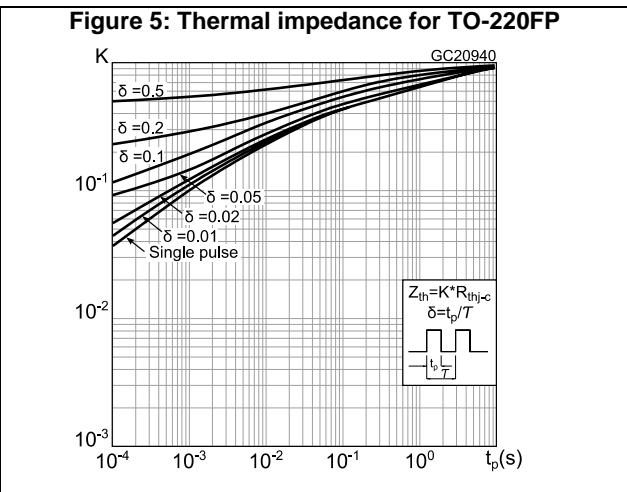
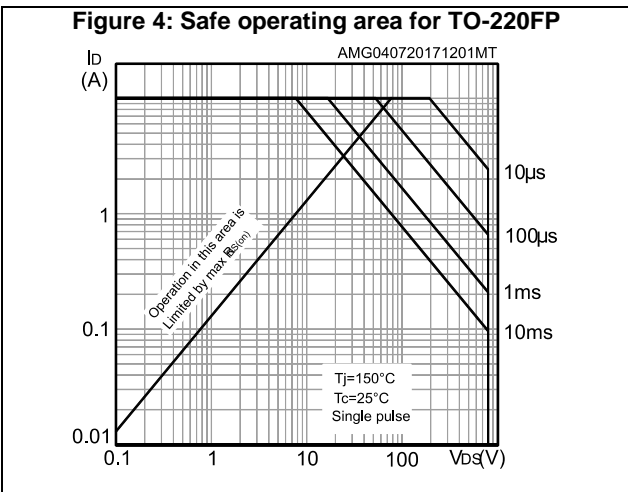
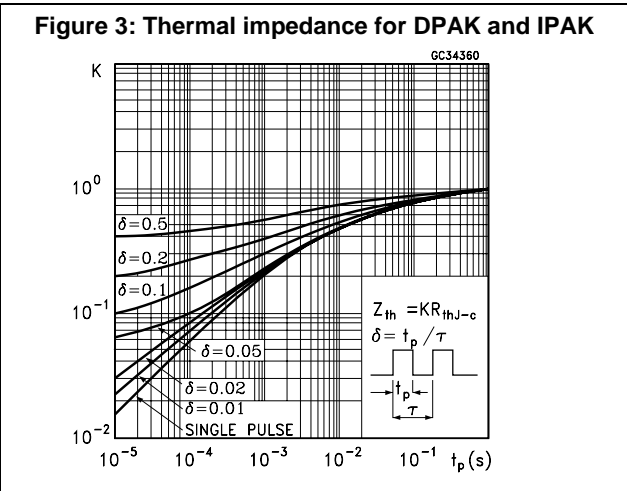
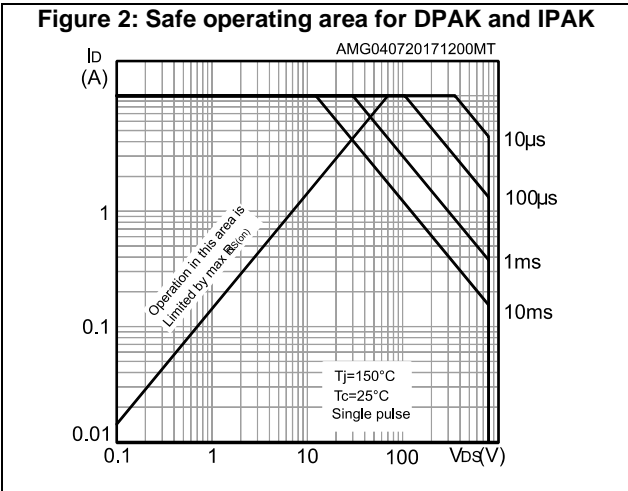
(2)Pulsed: pulse duration = 300 μs , duty cycle 1.5%

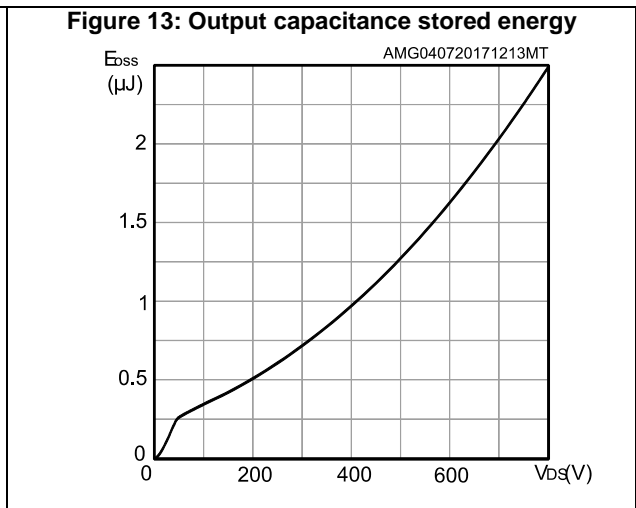
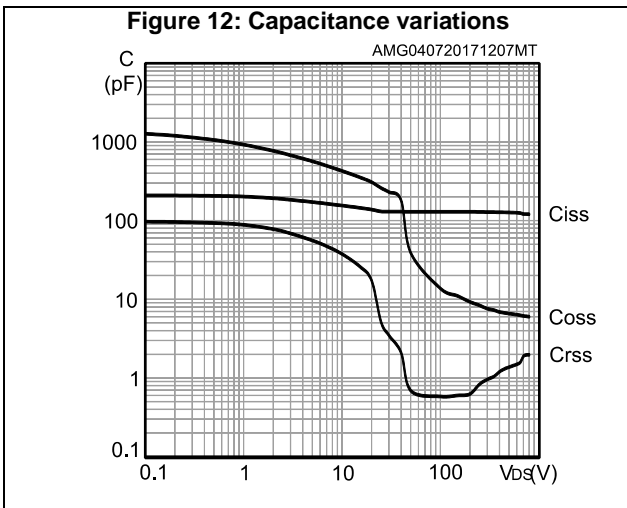
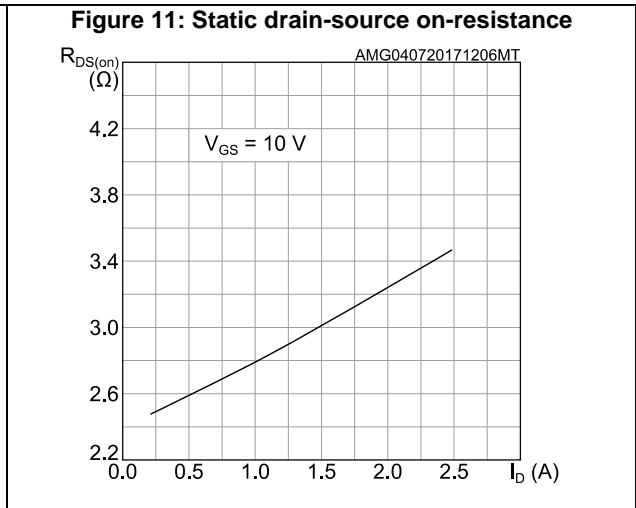
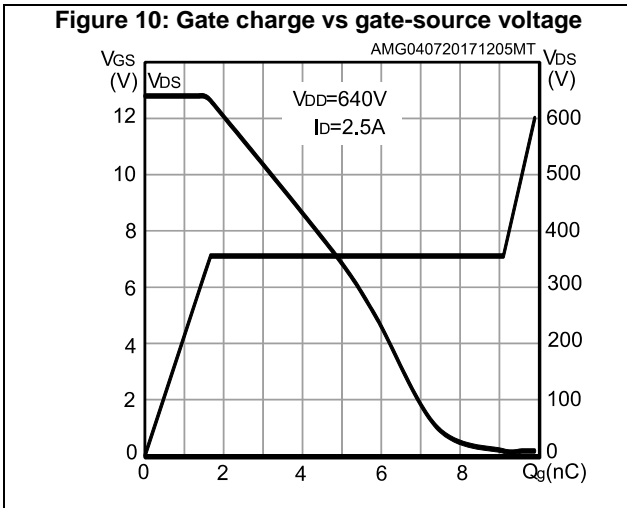
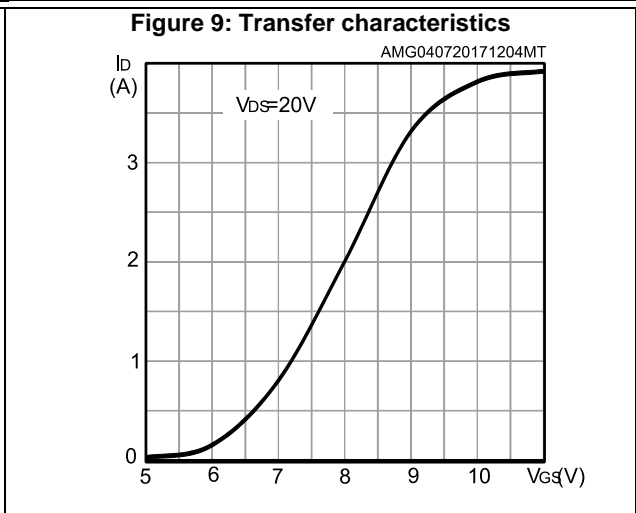
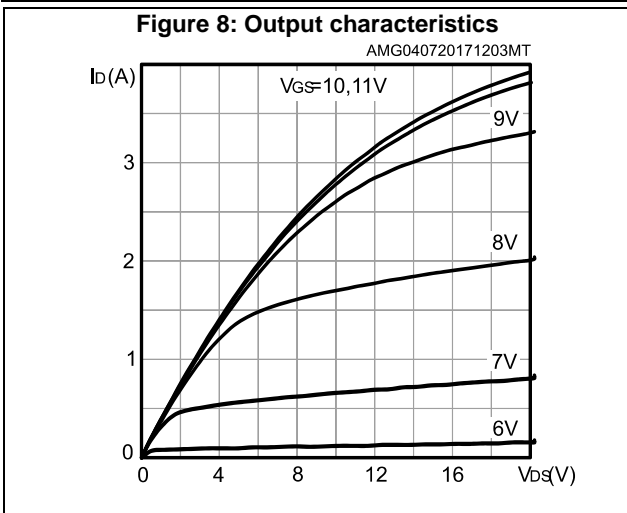
Table 9: Gate-source Zener diode

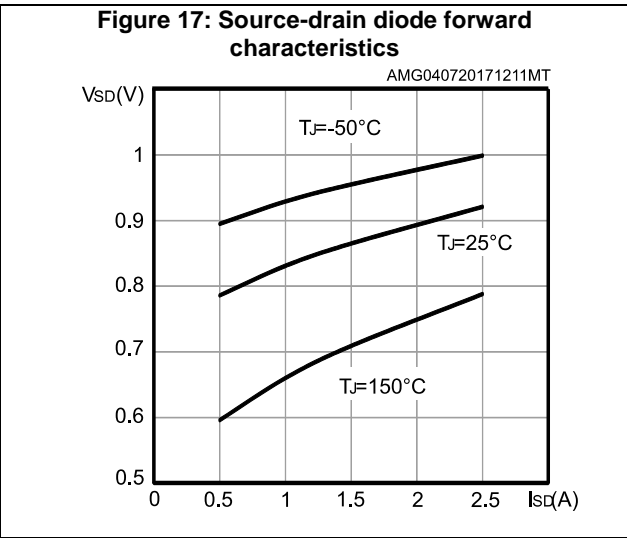
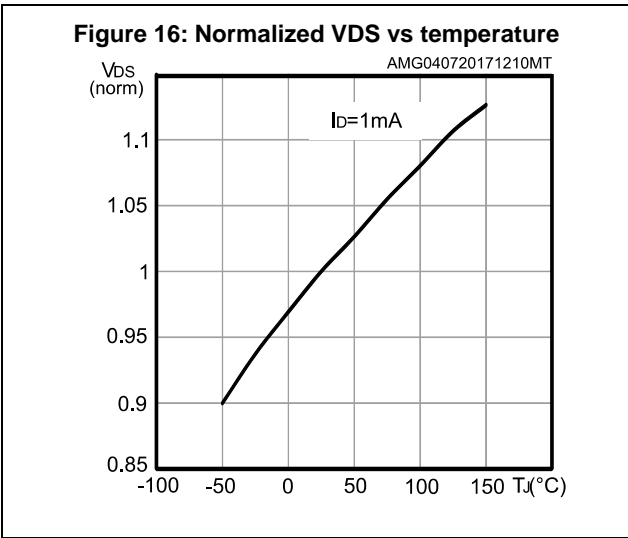
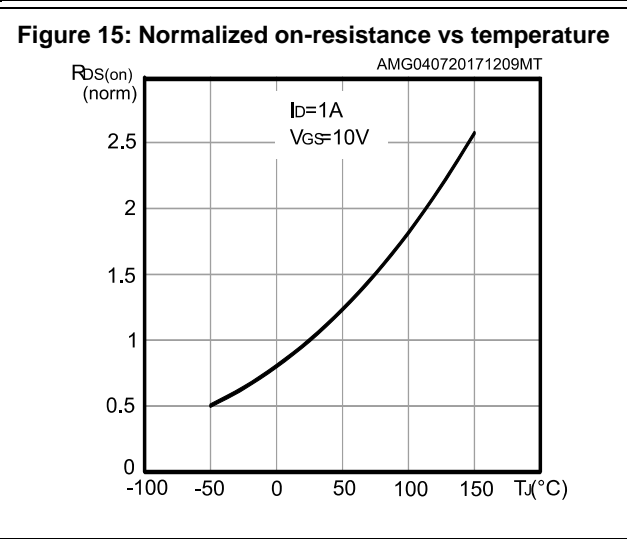
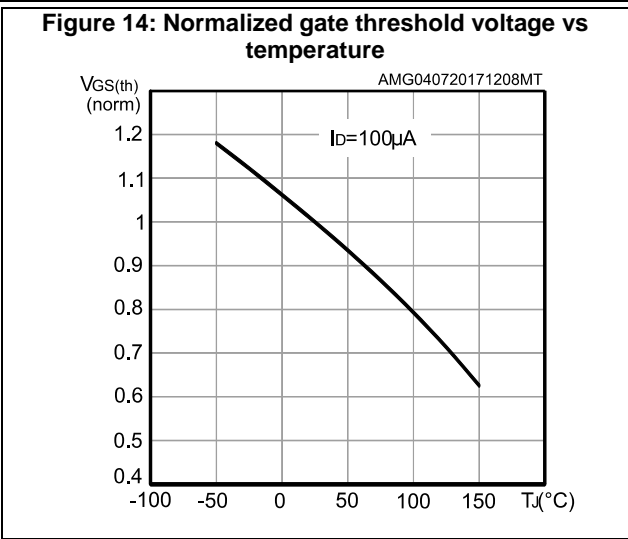
| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|---------------|-------------------------------|---|----------|------|------|------|
| $V_{(BR)GSO}$ | Gate-source breakdown voltage | $I_{GS} = \pm 1\text{ mA}$, $I_D = 0\text{ A}$ | ± 30 | - | - | V |

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

2.1 Electrical characteristics (curves)

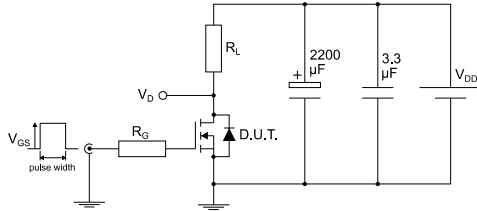






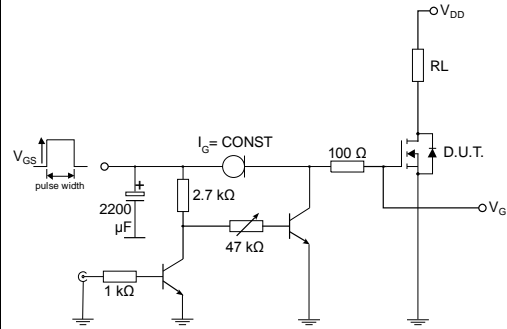
3 Test circuits

Figure 18: Test circuit for resistive load switching times



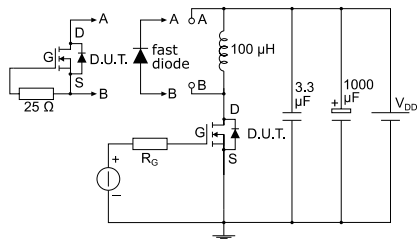
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Figure 19: Test circuit for gate charge behavior



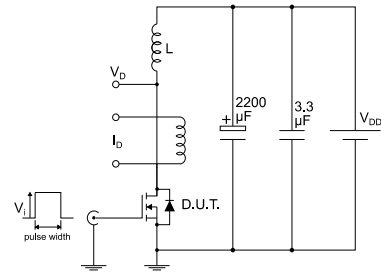
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Figure 20: Test circuit for inductive load switching and diode recovery times



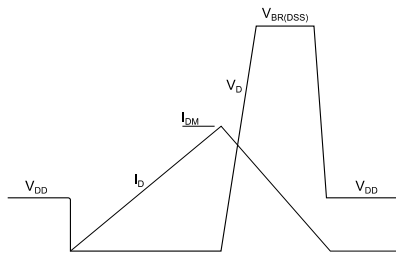
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Figure 21: Unclamped inductive load test circuit



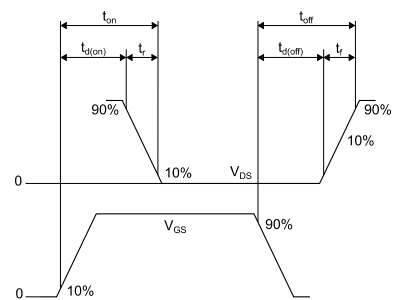
AM01471v1

Figure 22: Unclamped inductive waveform



AM01472v1

Figure 23: Switching time waveform



AM01473v1

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

4.1 DPAK (TO-252) type A package information

Figure 24: DPAK (TO-252) type A package outline

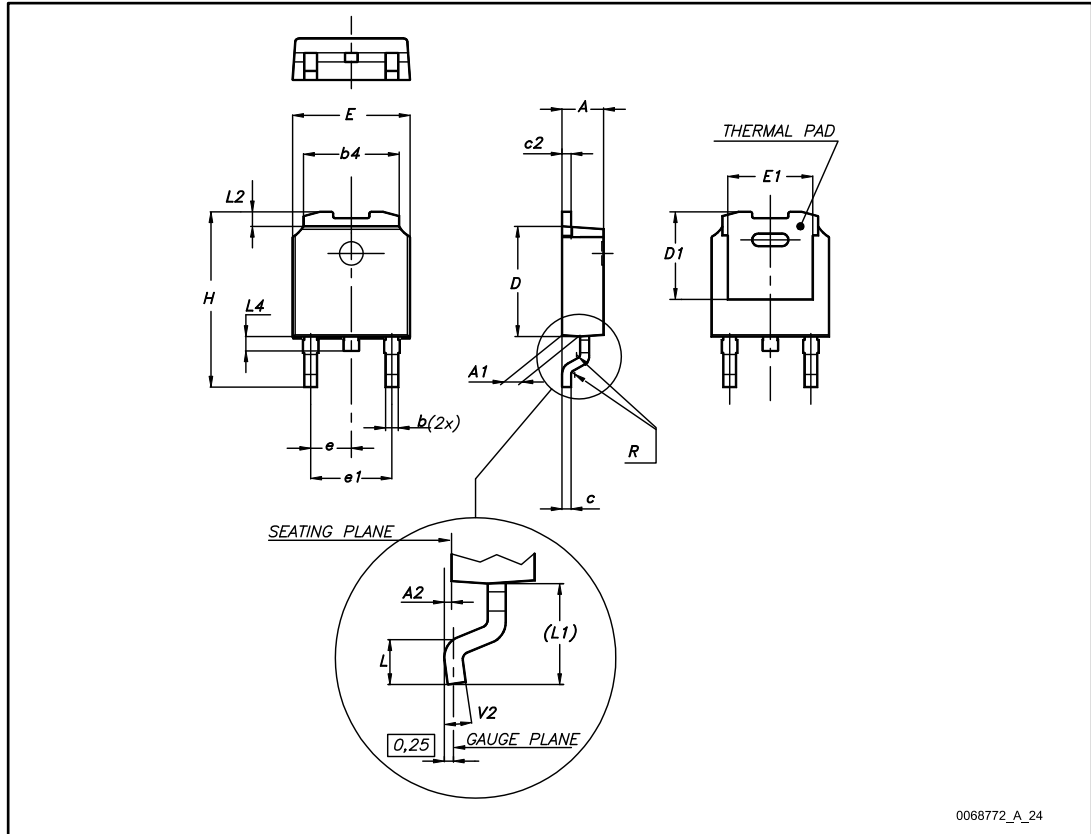
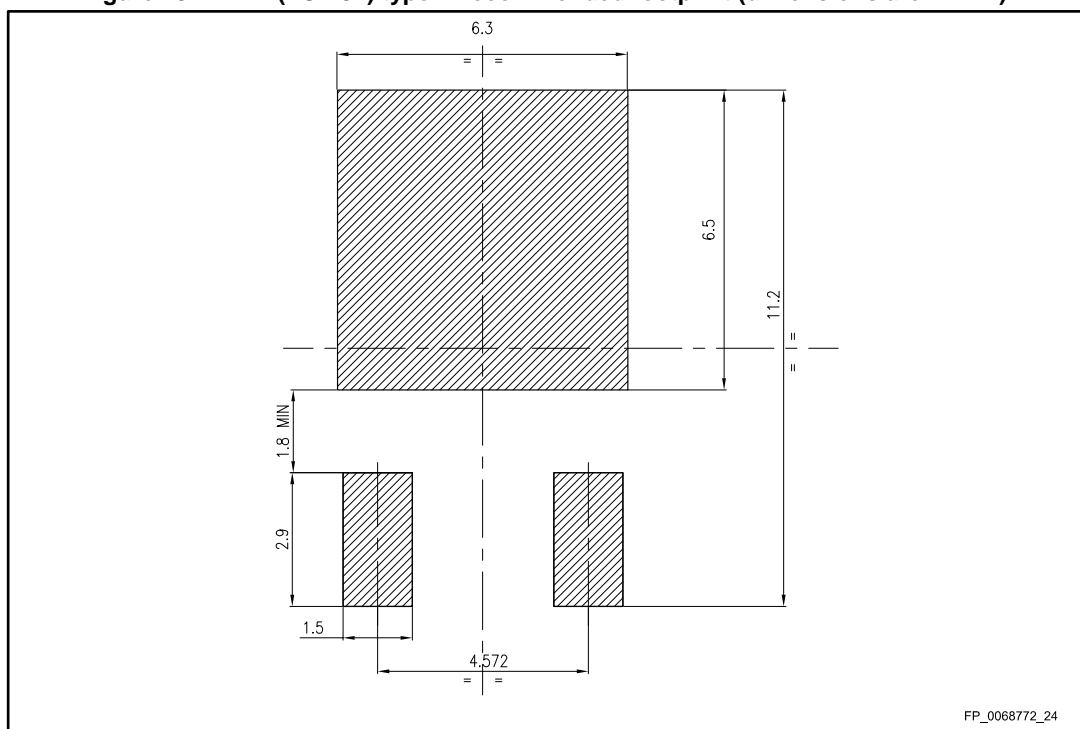


Table 10: DPAK (TO-252) type A mechanical data

| Dim. | mm | | |
|------|------|------|-------|
| | Min. | Typ. | Max. |
| A | 2.20 | | 2.40 |
| A1 | 0.90 | | 1.10 |
| A2 | 0.03 | | 0.23 |
| b | 0.64 | | 0.90 |
| b4 | 5.20 | | 5.40 |
| c | 0.45 | | 0.60 |
| c2 | 0.48 | | 0.60 |
| D | 6.00 | | 6.20 |
| D1 | 4.95 | 5.10 | 5.25 |
| E | 6.40 | | 6.60 |
| E1 | 4.60 | 4.70 | 4.80 |
| e | 2.16 | 2.28 | 2.40 |
| e1 | 4.40 | | 4.60 |
| H | 9.35 | | 10.10 |
| L | 1.00 | | 1.50 |
| (L1) | 2.60 | 2.80 | 3.00 |
| L2 | 0.65 | 0.80 | 0.95 |
| L4 | 0.60 | | 1.00 |
| R | | 0.20 | |
| V2 | 0° | | 8° |

Figure 25: DPAK (TO-252) type A recommended footprint (dimensions are in mm)



4.2 DPAK (TO-252) type E package information

Figure 26: DPAK (TO-252) type E package outline

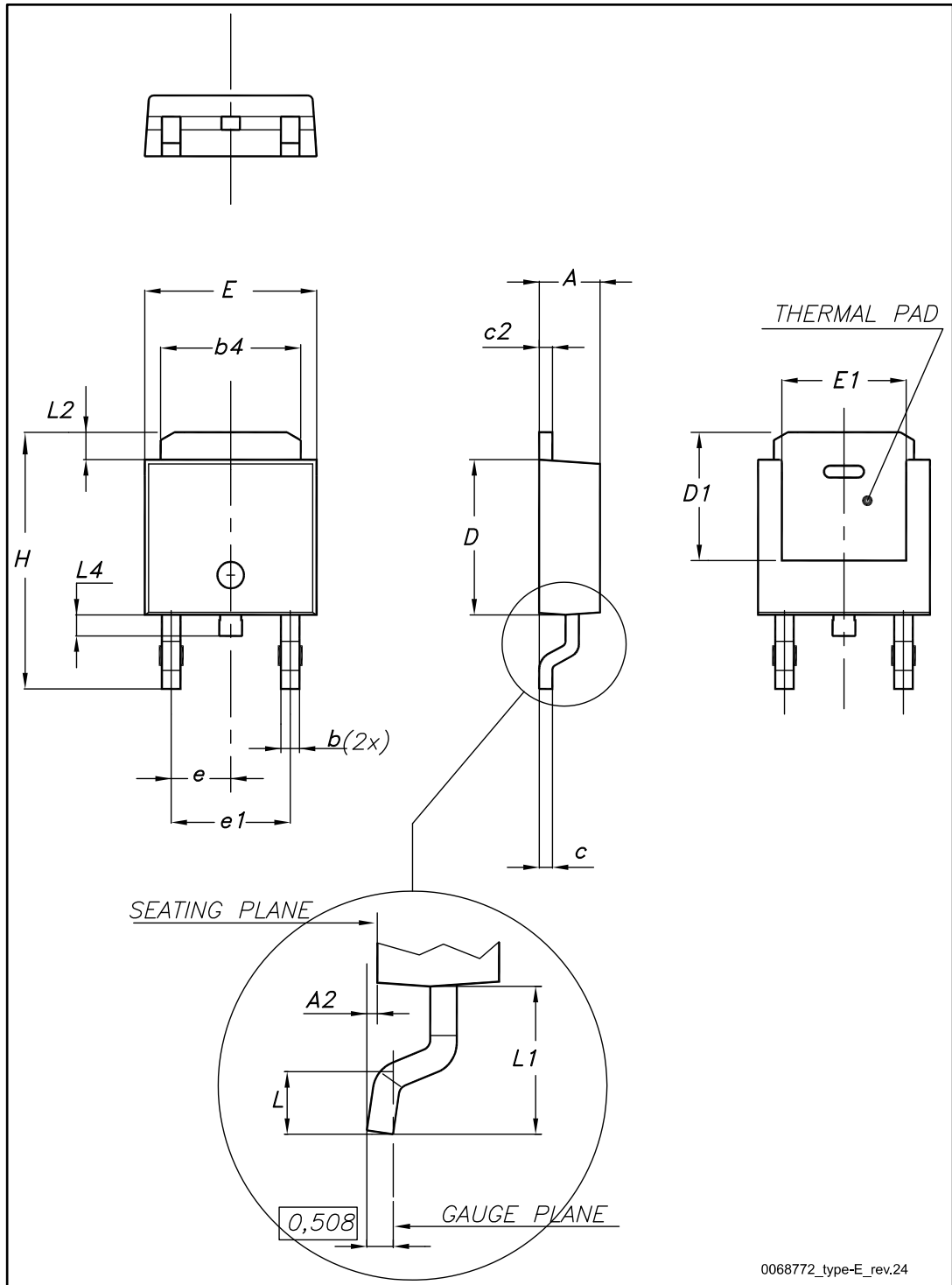
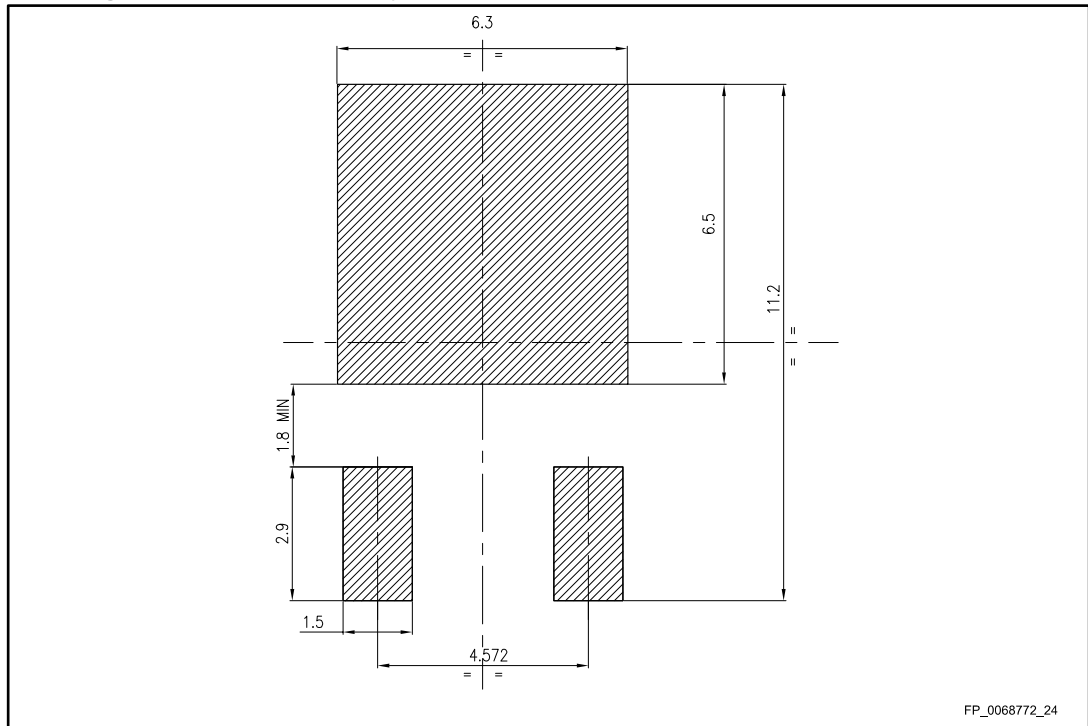


Table 11: DPAK (TO-252) type E mechanical data

| Dim. | mm | | |
|------|------|-------|-------|
| | Min. | Typ. | Max. |
| A | 2.18 | | 2.39 |
| A2 | | | 0.13 |
| b | 0.65 | | 0.884 |
| b4 | 4.95 | | 5.46 |
| c | 0.46 | | 0.61 |
| c2 | 0.46 | | 0.60 |
| D | 5.97 | | 6.22 |
| D1 | 5.21 | | |
| E | 6.35 | | 6.73 |
| E1 | 4.32 | | |
| e | | 2.286 | |
| e1 | | 4.572 | |
| H | 9.94 | | 10.34 |
| L | 1.50 | | 1.78 |
| L1 | | 2.74 | |
| L2 | 0.89 | | 1.27 |
| L4 | | | 1.02 |

Figure 27: DPAK (TO-252) type E recommended footprint (dimensions are in mm)



4.3 DPAK (TO-252) packing information

Figure 28: DPAK (TO-252) tape outline

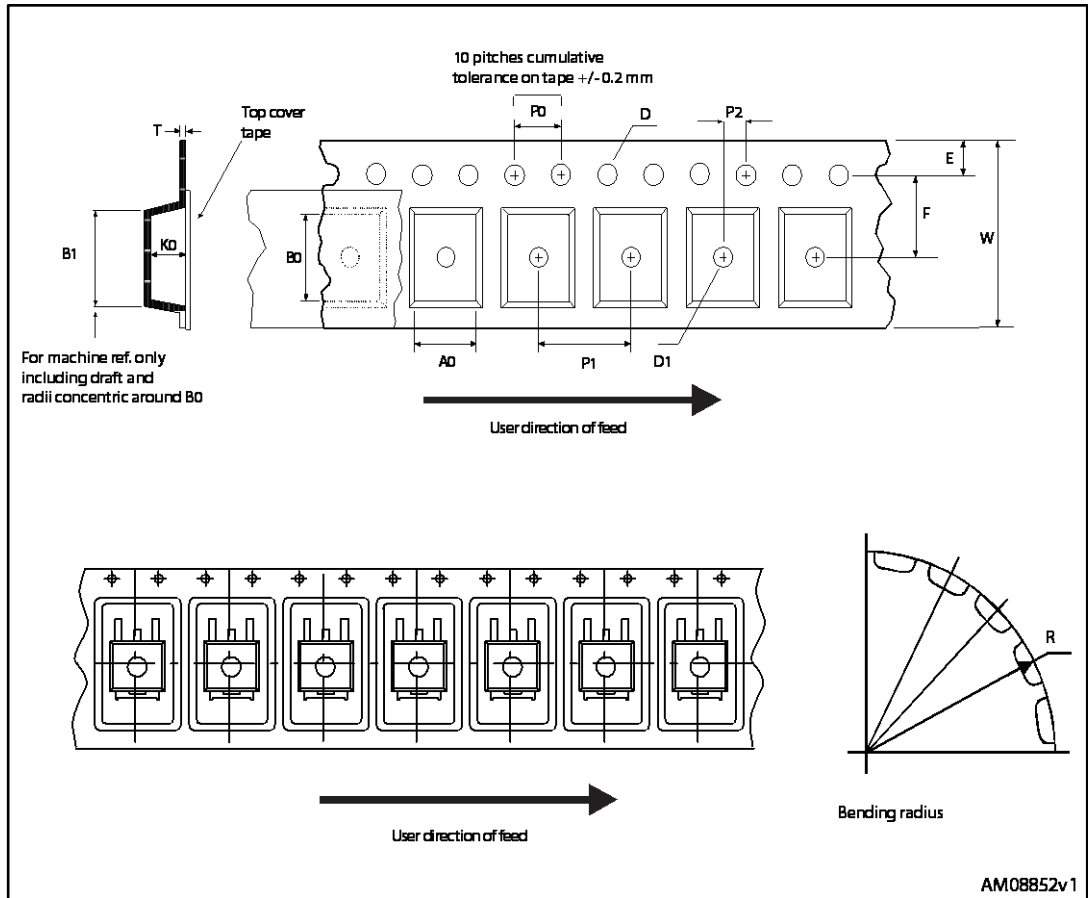
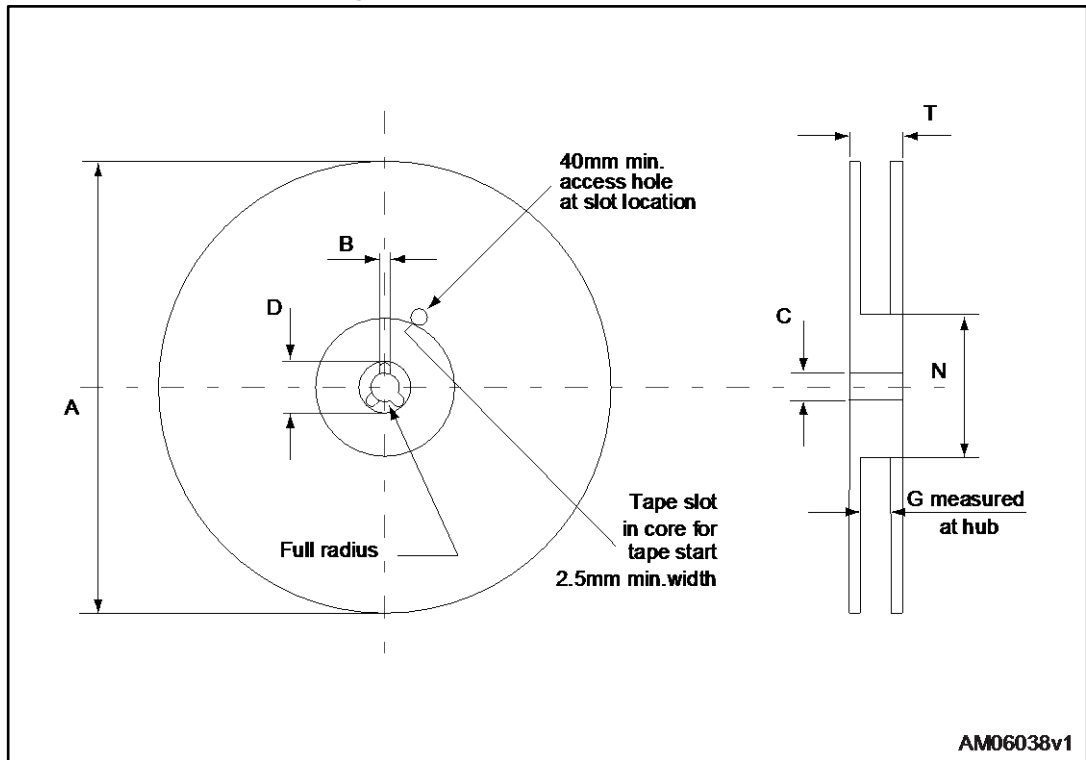


Figure 29: DPAK (TO-252) reel outline



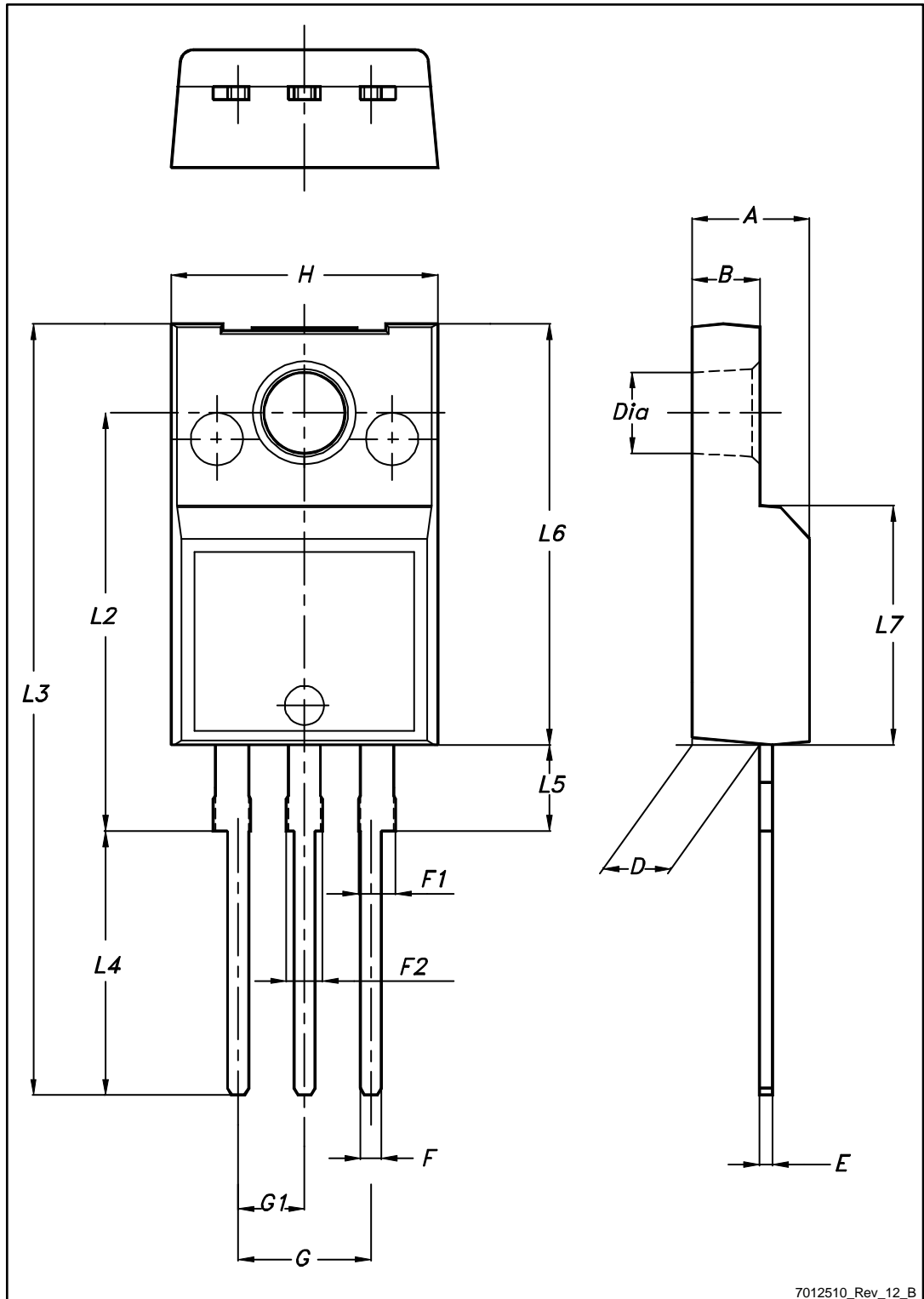
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Table 12: DPAK (TO-252) tape and reel mechanical data

| Tape | | | Reel | | |
|------|------|------|-----------|------|------|
| Dim. | mm | | Dim. | mm | |
| | Min. | Max. | | Min. | Max. |
| A0 | 6.8 | 7 | A | | 330 |
| B0 | 10.4 | 10.6 | B | 1.5 | |
| B1 | | 12.1 | C | 12.8 | 13.2 |
| D | 1.5 | 1.6 | D | 20.2 | |
| D1 | 1.5 | | G | 16.4 | 18.4 |
| E | 1.65 | 1.85 | N | 50 | |
| F | 7.4 | 7.6 | T | | 22.4 |
| K0 | 2.55 | 2.75 | | | |
| P0 | 3.9 | 4.1 | Base qty. | | 2500 |
| P1 | 7.9 | 8.1 | Bulk qty. | | 2500 |
| P2 | 1.9 | 2.1 | | | |
| R | 40 | | | | |
| T | 0.25 | 0.35 | | | |
| W | 15.7 | 16.3 | | | |

4.4 TO-220FP package information

Figure 30: TO-220FP package outline



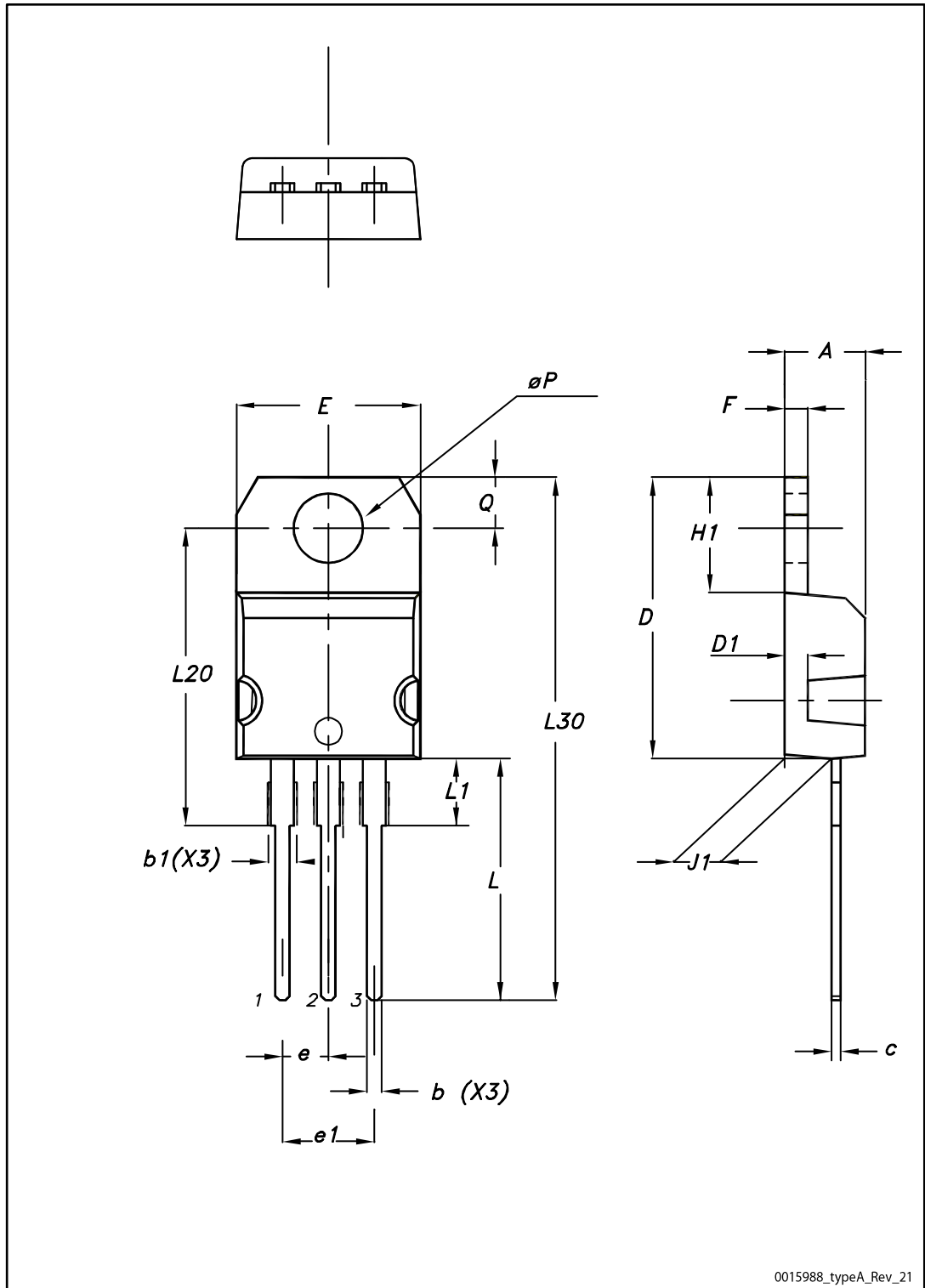
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Table 13: TO-220FP package mechanical data

| Dim. | mm | | |
|------|------|------|------|
| | Min. | Typ. | Max. |
| A | 4.4 | | 4.6 |
| B | 2.5 | | 2.7 |
| D | 2.5 | | 2.75 |
| E | 0.45 | | 0.7 |
| F | 0.75 | | 1 |
| F1 | 1.15 | | 1.70 |
| F2 | 1.15 | | 1.70 |
| G | 4.95 | | 5.2 |
| G1 | 2.4 | | 2.7 |
| H | 10 | | 10.4 |
| L2 | | 16 | |
| L3 | 28.6 | | 30.6 |
| L4 | 9.8 | | 10.6 |
| L5 | 2.9 | | 3.6 |
| L6 | 15.9 | | 16.4 |
| L7 | 9 | | 9.3 |
| Dia | 3 | | 3.2 |

4.5 TO-220 type A package information

Figure 31: TO-220 type A package outline



0015988_typeA_Rev_21

Table 14: TO-220 type A package mechanical data

| Dim. | mm | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 4.40 | | 4.60 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.55 |
| c | 0.48 | | 0.70 |
| D | 15.25 | | 15.75 |
| D1 | | 1.27 | |
| E | 10.00 | | 10.40 |
| e | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| F | 1.23 | | 1.32 |
| H1 | 6.20 | | 6.60 |
| J1 | 2.40 | | 2.72 |
| L | 13.00 | | 14.00 |
| L1 | 3.50 | | 3.93 |
| L20 | | 16.40 | |
| L30 | | 28.90 | |
| øP | 3.75 | | 3.85 |
| Q | 2.65 | | 2.95 |

4.6 IPAK (TO-251) type A package information

Figure 32: IPAK (TO-251) type A package outline

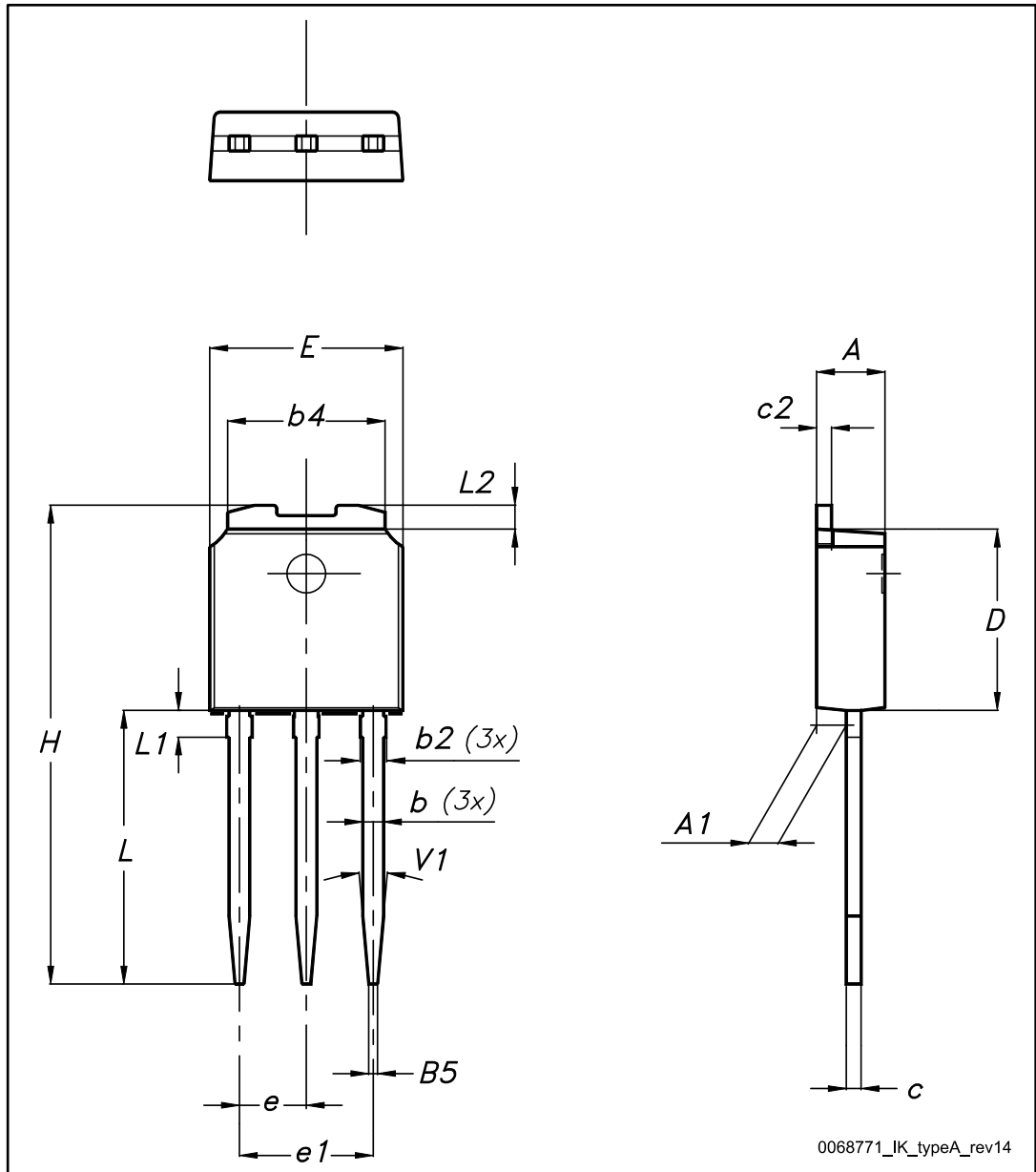


Table 15: IPAK (TO-251) type A package mechanical data

| Dim. | mm | | |
|------|------|-------|------|
| | Min. | Typ. | Max. |
| A | 2.20 | | 2.40 |
| A1 | 0.90 | | 1.10 |
| b | 0.64 | | 0.90 |
| b2 | | | 0.95 |
| b4 | 5.20 | | 5.40 |
| B5 | | 0.30 | |
| c | 0.45 | | 0.60 |
| c2 | 0.48 | | 0.60 |
| D | 6.00 | | 6.20 |
| E | 6.40 | | 6.60 |
| e | | 2.28 | |
| e1 | 4.40 | | 4.60 |
| H | | 16.10 | |
| L | 9.00 | | 9.40 |
| L1 | 0.80 | | 1.20 |
| L2 | | 0.80 | 1.00 |
| V1 | | 10° | |

5 Revision history

Table 16: Document revision history

| Date | Revision | Changes |
|-------------|----------|--|
| 12-Jul-2013 | 1 | First release. |
| 15-Jan-2014 | 2 | <ul style="list-style-type: none"> – Modified: PTOT and EAS values in Table 2 – Modified: Rthj-case values in Table 3 – Modified: the entire typical values in Table 5 and 6 – Modified: ISD and ISDM max values and typical values in Table 7 – Updated: Table 24 and Table 9 – Added: Section 2.1: Electrical characteristics (curves) – Minor text changes |
| 17-Jan-2014 | 3 | <ul style="list-style-type: none"> – Modified: Figure 8 and 9 – Minor text changes |
| 17-Jul-2017 | 4 | Updated Table 7: "Switching times" and Section 4: "Package information" . Minor text changes. |

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